

**LINEAR TECHNOLOGY MATERIALS DECLARATION**

1t1307bcs8#pbf

(Engineering Calculation)

SOIC

(printed on: 2020-07-11 20:07:01)

**TOTAL MASS (g) : 0.07377**

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.002273	1000000	30812.0449219		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.023653	975000	320632.34375		
		Iron (Fe)	7439-89-6	0.000582	24000	7889.40185547		
		Phosphorus (P)	7723-14-0	0.000007	300	94.8897171021		
		Zinc (Zn)	7440-66-6	0.000017	700	230.44644165		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
<b>Lead Frame Total:</b>				<b>0.024259</b>	<b>1000000</b>	<b>328847.0625</b>		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.001477	1000000	20019.7226562		
		<b>External Plating Total:</b>				<b>0.001477</b>	<b>1000000</b>	<b>20019.7226562</b>
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000194	1000000	2629.80053711		
		<b>Internal Plating Total:</b>				<b>0.000194</b>	<b>1000000</b>	<b>2629.80053711</b>
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.000751	750000	10180.3105469		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000250	250000	3388.91845703		
<b>Die Attach Total:</b>				<b>0.001001</b>	<b>1000000</b>	<b>13569.2294922</b>		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.006657	150000	90240.1171875		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.036392	820000	493318.0625		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.001110	25000	15046.796875		
		Carbon Black (C)	1333-86-4	0.000222	5000	3009.359375		
		<b>Encapsulation Total:</b>				<b>0.044381</b>	<b>1000000</b>	<b>601614.3125</b>
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000185	1000000	2507.79956055		
					<b>TOTAL MASS (g) :</b>	<b>0.07377</b>		